

SHINDENGEN

General Purpose Rectifiers

Dual

S1ZA20

200V 1.1A

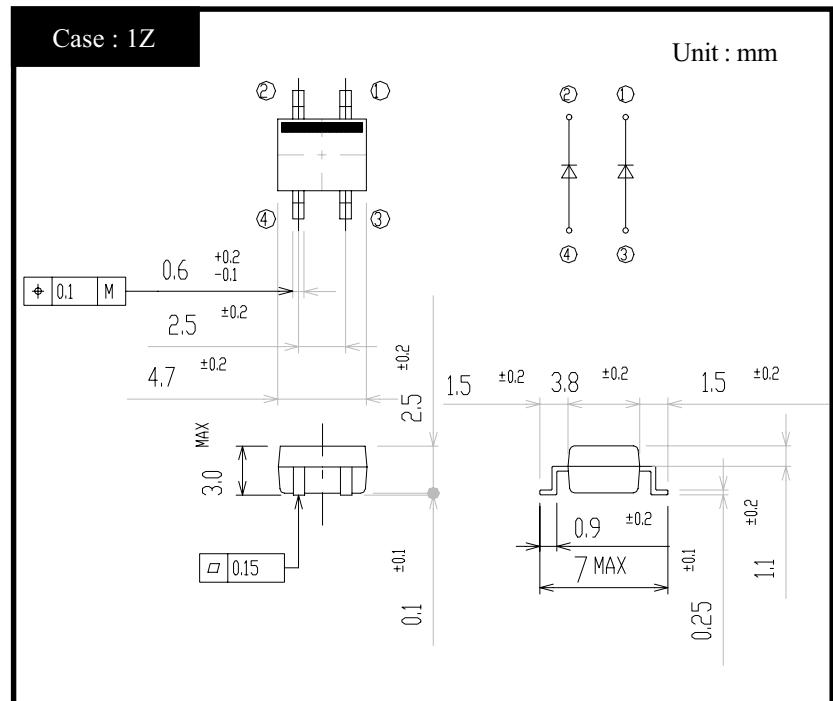
FEATURES

- Small SMT package
- Array
- High reliability with superior moisture resistance
- Applicable to Automatic Insertion

APPLICATION

- Conventional Rectification
- Motor
- Home Appliances, Office Equipment
- Telecommunication, Factory Automation

OUTLINE DIMENSIONS



RATINGS

● Absolute Maximum Ratings (If not specified $T_f=25^\circ\text{C}$)

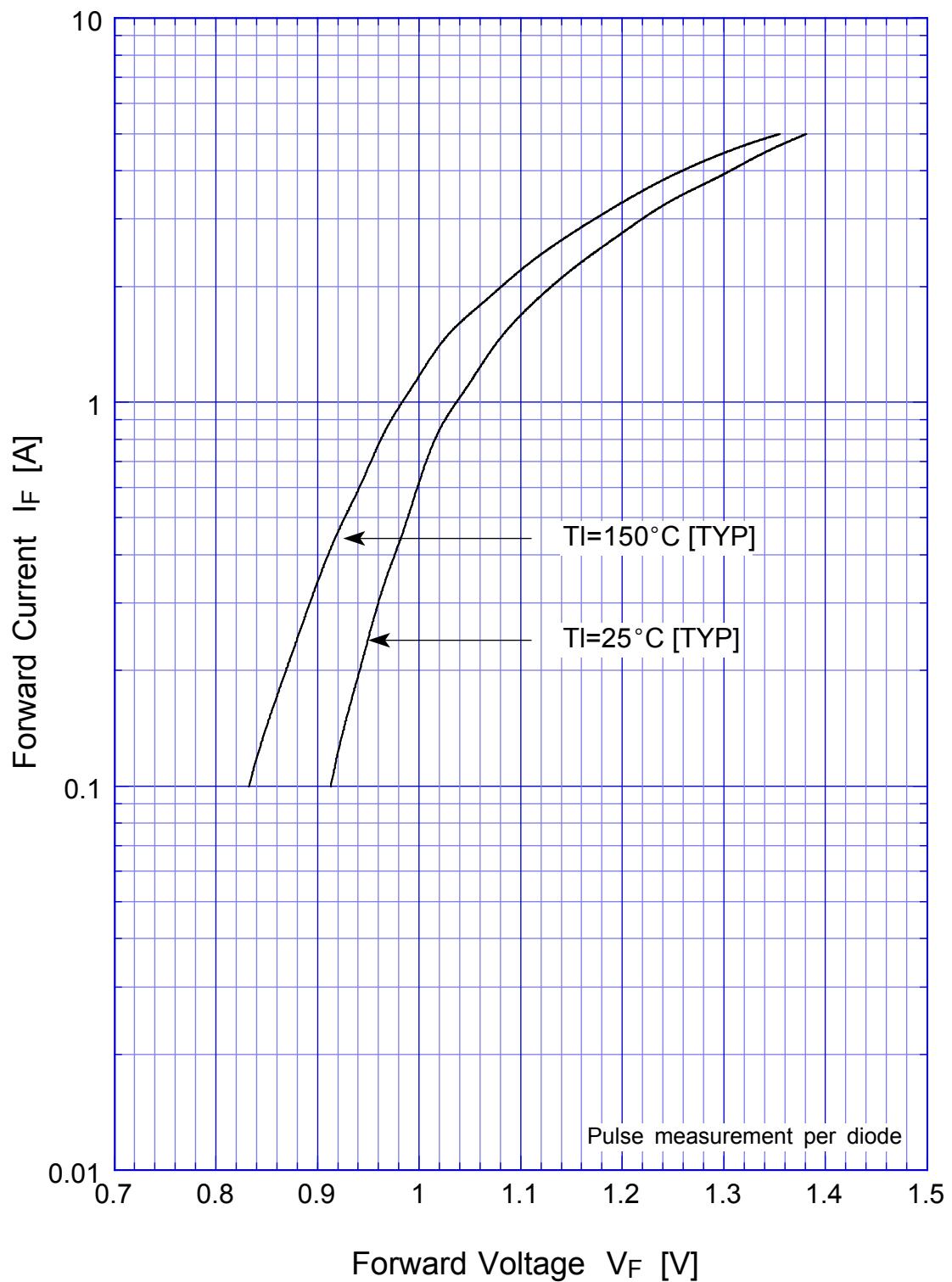
Item	Symbol	Conditions	Ratings	Unit
Storage Temperature	T_{stg}		-40~150	$^\circ\text{C}$
Operating Junction Temperature	T_j		150	$^\circ\text{C}$
Maximum Reverse Voltage	V_{RM}		200	V
Average Rectified Forward Current	I_O	50Hz sine wave, R-load $T_a=25^\circ\text{C}$ On alumina substrate 1 element operation	1.1	A
		50Hz sine wave, R-load $T_a=25^\circ\text{C}$ On alumina substrate 2 element operation	0.8	
		50Hz sine wave, R-load $T_a=25^\circ\text{C}$ On glass-epoxy substrate 1 element operation	0.9	
		50Hz sine wave, R-load $T_a=25^\circ\text{C}$ On glass-epoxy substrate 2 element operation	0.63	
Peak Surge Forward Current	I_{FSM}	50Hz sine wave, Non-repetitive 1cycle peak value, $T_j=25^\circ\text{C}$	30	A

● Electrical Characteristics (If not specified $T_f=25^\circ\text{C}$)

Item	Symbol	Conditions	Ratings	Unit
Forward Voltage	V_F	$I_F=0.9\text{A}$, Pulse measurement, Rating of per diode	Max.1.1	V
Reverse Current	I_R	$V_R=V_{RM}$, Pulse measurement, Rating of per diode	Max.10	μA
Thermal Resistance	θ_{ja}	junction to ambient On alumina substrate 1 element operation	Max.93	$^\circ\text{C}/\text{W}$
		junction to ambient On alumina substrate 2 element operation	Max.140	
		junction to ambient On glass-epoxy substrate 1 element operation	Max.120	
		junction to ambient On glass-epoxy substrate 2 element operation	Max.186	

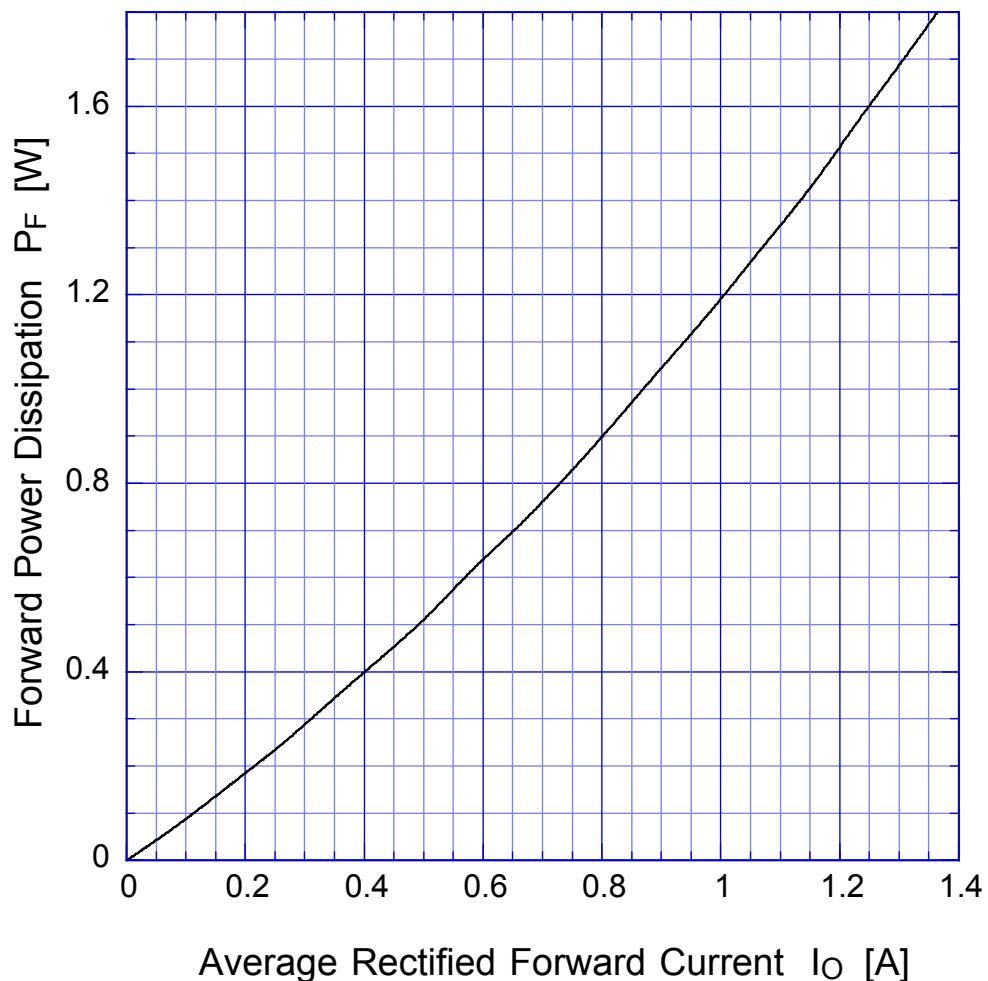
S1ZAx

Forward Voltage

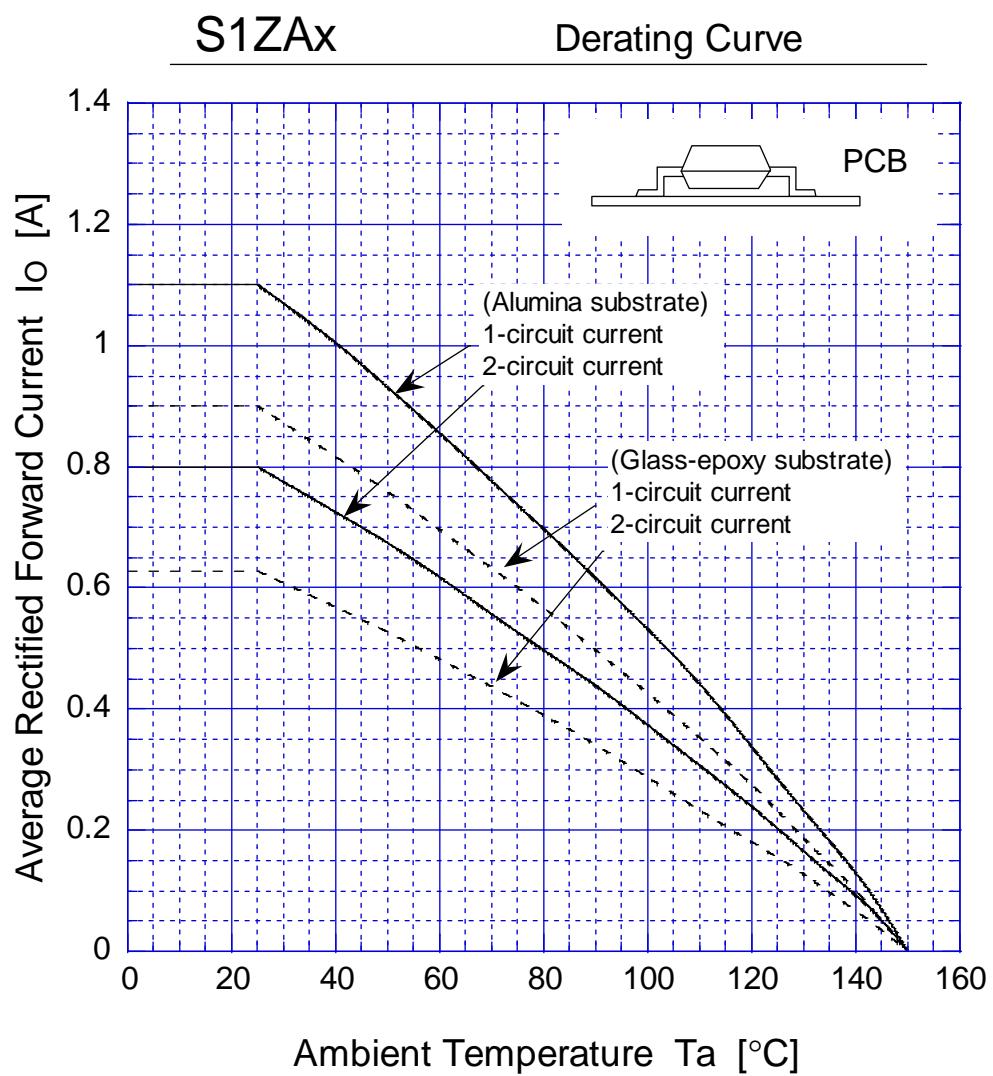


S1ZAx

Forward Power Dissipation



$T_j = 150^\circ\text{C}$
Sine wave



Alumina substrate
Soldering land 1mm×1mm
Conductor layer 20 μ m
Substrate thickness 0.64mm

Glass-epoxy substrate
Soldering land 1mm×1mm
Conductor layer 35 μ m

Sine wave
R-load
Free in air

S1ZAx

Peak Surge Forward Capability

